

<b>Application Number</b> 	Application No.	Applicant(s)
	10/678,139	YAMAZAKI ET AL.
	Terminal Disclaimer Filed: 03/29/2006	

<b>TERMINAL DISCLAIMER</b>	<input checked="" type="checkbox"/> APPROVED	<input type="checkbox"/> DISAPPROVED
Document Code - DISQ	Reasons:	
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U.S. Patent and Trademark Office

**NOTE DISCLAIMER:**

The term of this patent shall not extend  
beyond the expiration date of Pat. No. 6,331,457.

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Docket No. 0756-2659

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re PATENT application of

SHUNPEI YAMAZAKI et al.

Serial No. 10/678,139

Filed: October 6, 2003

For: METHOD FOR FABRICATING SEMICONDUCTOR THIN FILM)

)

)

) Art Unit: 2822

) Examiner: GUERRERO

TERMINAL DISCLAIMER

Commissioner for Patents

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Sir:

I, Dr. Shunpei Yamazaki, having a place of business at Semiconductor Energy Laboratory Co., Ltd., 398, Hase, Atsugi-shi, Kanagawa-ken 243-0036 Japan, state that I am authorized to sign on behalf of the assignee of this invention and that the Assignment referred to below has been reviewed and certify that, to the best of my knowledge and belief, the entire right, title and interest in the above-identified application is in the name of Semiconductor Energy Laboratory Co., Ltd. by virtue of an Assignment recorded in the U.S. Patent and Trademark Office at Reel 07701, Frame 0233-0225.

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Docket No. 0756-2659

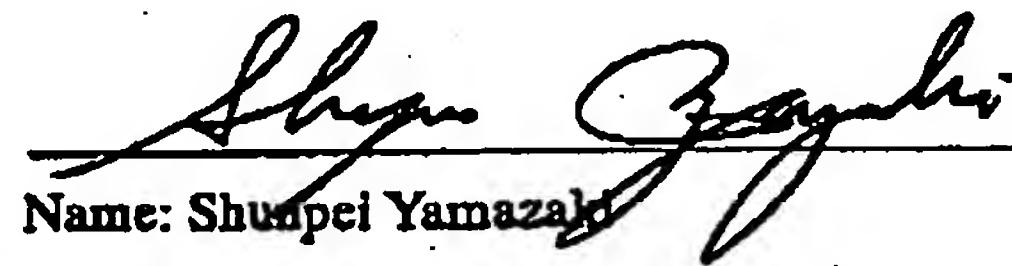
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09/20/2006

Date



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